

plerow[™] ALN1811BT

Internally Matched LNA Module

Features

- · S₂₁ = 14.9 dB @ 1750 MHz
 - = 14.1 dB @ 1870 MHz
- NF of 0.8 dB over Frequency
- · Unconditionally Stable
- · Single 5V Supply
- · High OIP3 @ Low Current

Parameter

Frequency Range

Gain Flatness

Noise Figure

Output IP3⁽¹⁾

S11 / S22 (2)

Output P1dB

Switching Time

Supply Current

Supply Voltage

Impedance

Gain

Specifications (in Production)

Description

Unit

MHz

dB

dB

dB

dBm

dB

dBm

μsec

mΑ

V

Ω

dBm

mm

The plerow[™] ALN-series is the compactly designed surface-mount module for the use of the LNA with or without the following gain blocks in the infrastructure equipment of the mobile wireless (CDMA, GSM, PCS, PHS, WCDMA, DMB, WLAN, WiBro, WiMAX), GPS, satellite communication terminals, CATV and so on. It has an exceptional performance of low noise figure, high gain, high OIP3, and low bias current. The stability factor is always kept more than unity over the application band in order to ensure its unconditionally stable implementation to the application system environment. The surface-mount module package including the completed matching circuit and other components necessary just in case allows very simple and convenient implementation onto the system board in mass production level.

Typ. @ T = 25°C, V_s = 5 V, Freq. = 1810 MHz, $Z_{o.sys}$ = 50 ohm

Min

1750

13.5

30

16

Specifications

Тур

14.5

± 0.4

0.8

31

17

_

45

5

50 C.W 23 ~ 25 (before fail)

Surface Mount Type, 10Wx10Lx3.8H

Max

1870

± 0.5

0.85

-18 / -10

55







1-stage Single Type

More Information

Website: www.asb.co.kr E-mail: sales@asb.co.kr

Tel: (82) 42-528-7223 Fax: (82) 42-528-7222

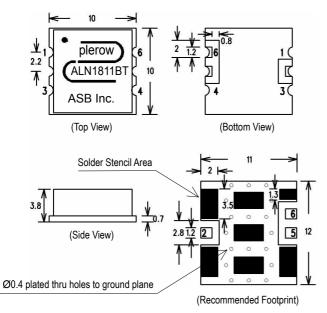
ASB Inc., 4th FI. Venture Town Bldg., 367-17 Goijeong-Dong, Seo-Gu, Daejon 302-716, Korea

Package Type & Size Operating temperature is -40°C to +85°C.

Max. RF Input Power

1) OIP3 is measured with two toes at an output power of 4 dBm / tone separated by 1 MHz.
2) S11/S22 (max) is the worst value within the frequency band.
3) Switching time means the time that takes for output power to get stabilized to its final level after switching DC voltage from 0 V to V_S.

Outline Drawing (Unit: mm)



Pin Number	Function
2	RF In
5	RF Out
6	+Vcc
Others	Ground

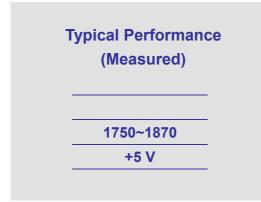
Note: 1. The number and size of ground via holes in a circuit board is critical for thermal RF grounding considerations.

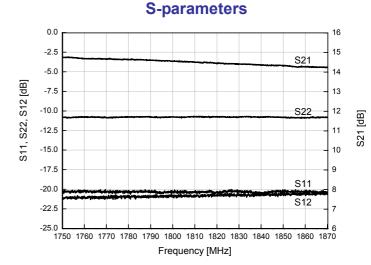
2. We recommend that the ground via holes be placed on the bottom of all ground pins for better RF and thermal performance, as shown in the drawing at the left side.



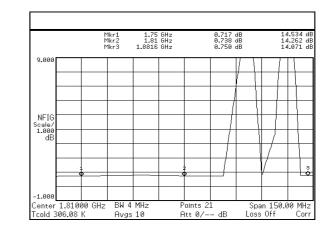
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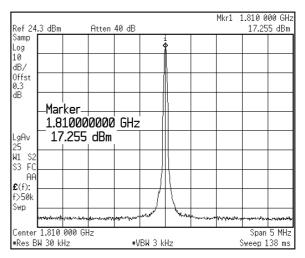




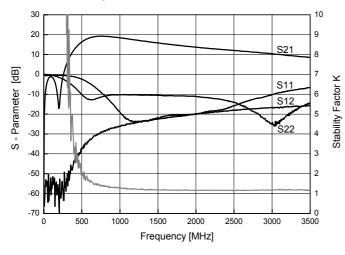
Noise Figure



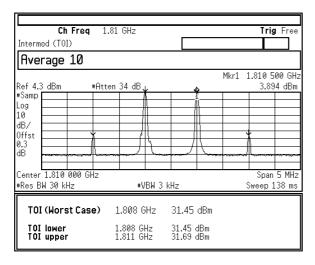
P1dB



S-parameters & K Factor



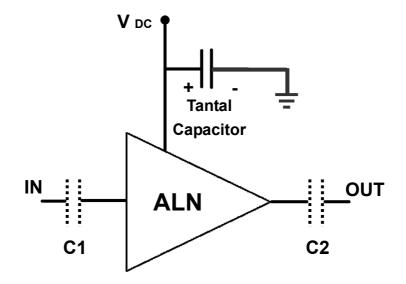
OIP3





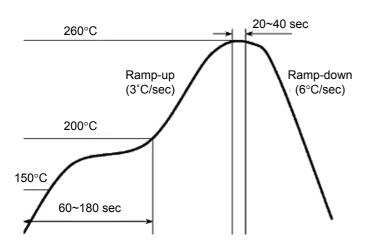
Internally Matched LNA Module

Application Circuit

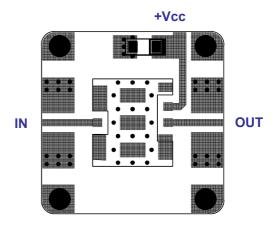


- The tantal capacitor is optional and for bypassing the AC noise introduced from the DC supply. The capacitance value may be determined by customer's DC supply status.
- 2) So-called DC blocking capacitors are always necessarily placed at the input and output port for allowing only the RF signal to pass and blocking the DC component in the signal. The DC blocking capacitors are included inside the LNA module. Therefore, C1 & C2 capacitors may not be necessary, but can be added just in case that the customer wants. The value of C1 & C2 is determined by considering the application frequency.

Recommended Soldering Reflow Process



Evaluation Board Layout



Size 25 x 25mm (for ALN-AT, BT, T Series – 10x10mm)